PRODUCT / PROCESS CHANGE NOTIFICATION

| 1. PCN basic data | | | |
|----------------------|----|---|--|
| 1.1 Company | | STMicroelectronics International N.V | |
| 1.2 PCN No. | Į. | ADG/20/12338 | |
| 1.3 Title of PCN | C | Qualification of SMA & SMB packages at Assembly/Test location in China | |
| 1.4 Product Category | | - Power Schottky, Ultrafast - SM6T, SMAJ and SMBJ products with • 40V <= Vrm <= 70V • 46V <= Vbr <= 82V | |
| 1.5 Issue date | 2 | 2020-09-16 | |

| 2. PCN Team | | |
|---------------------------|-------------------------|--|
| 2.1 Contact supplier | | |
| 2.1.1 Name | NEMETH KRISZTINA | |
| 2.1.2 Phone | +49 89460062210 | |
| 2.1.3 Email | krisztina.nemeth@st.com | |
| 2.2 Change responsibility | | |
| 2.2.1 Product Manager | Stephane CHAMARD | |
| 2.1.2 Marketing Manager | Philippe LEGER | |
| 2.1.3 Quality Manager | Jean-Paul REBRASSE | |

| 3. Change | | |
|--------------|--------------------|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| Machines | (Not Defined) | subco in China |

| 4. Description of change | | | |
|---|------------------------|--|--|
| Old New | | | |
| 4.1 Description | assembly line in China | new assembly line of SMA & SMB package subcontracted in China (same subco) | |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | no | | |

| 5. Reason / motivation for change | | |
|---|-------------------|--|
| 5.1 Motivation STMicroelectronics has decided to expand the manufacturing capacity of Rectifiers and T protection devices housed in SMA & SMB package | | |
| 5.2 Customer Benefit | CAPACITY INCREASE | |

| 6. Marking of parts / traceability of change | | |
|--|-------------------------------------|--|
| 6.1 Description | internal codification and QA number | |

| 7. Timing / schedule | | |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results | 2020-09-15 | |
| 7.2 Intended start of delivery | 2020-12-07 | |
| 7.3 Qualification sample available? | Upon Request | |

| 8. Qualification / Validation | | | |
|--|-------------|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | In progress | Issue Date | |

9. Attachments (additional documentations)

12338 Public product.pdf 12338 Qualification of SMA SMB packages at Assembly Test location in China.pdf

| 10. Affected parts | | | |
|-------------------------|---|--------------------------|--|
| 10. 1 Current 10.2 | | 10.2 New (if applicable) | |
| 10.1.1 Customer Part No | .1.1 Customer Part No 10.1.2 Supplier Part No | | |
| | SM6T56CA | | |
| | STTH1R04A | | |

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